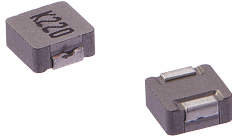




**THE DATASHEET OF  
MDA4020-6R8M**



**MDA Series**  
**SMD Low Profile High Current Molded Inductor**  
**Size 4020**



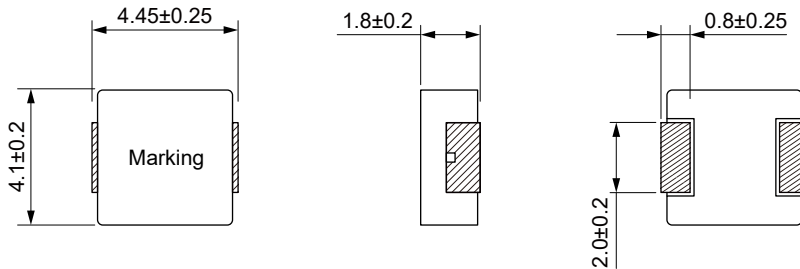
**FEATURES**

- Shielded construction
- Capable of corresponding high frequency .
- Low loss realized with low DCR.
- High performance (Isat) realized by metal dust core.
- Ultra low buzz noise, due to composite construction.
- 100% Lead(Pb)-Free and RoHS compliant.
- AEC-Q200 qualified
- Operating temperature: -55 to +155 °C(including self-temperature rise)
- Quantity: 3000PCS

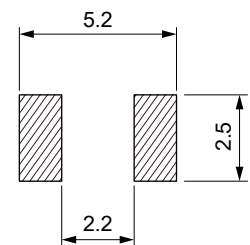
**APPLICATION**

- Headlamps, tail lamps and interior lighting
- HVAC
- Doors, window lift and seat control
- Audio subsystem
- Digital instrument cluster
- In-Vehicle Infotainment and navigation

**Dimensions: [mm]**



**Land Pattern: [mm]**



**Electrical Properties:**

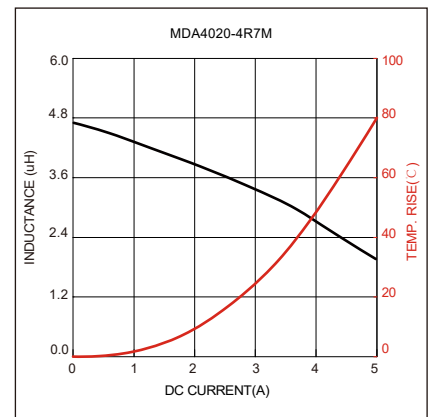
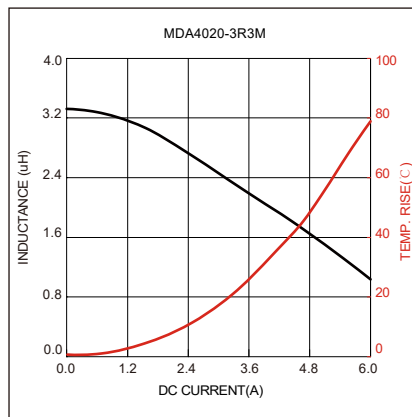
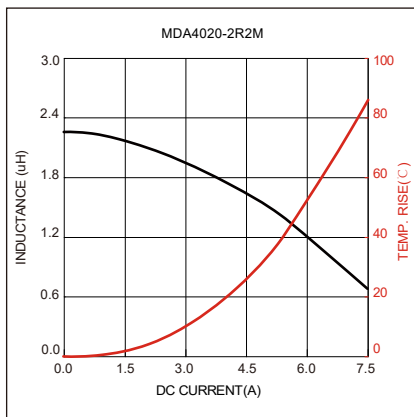
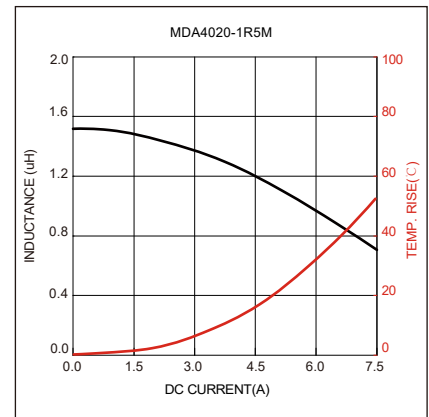
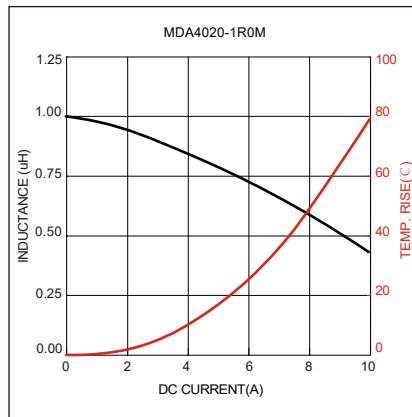
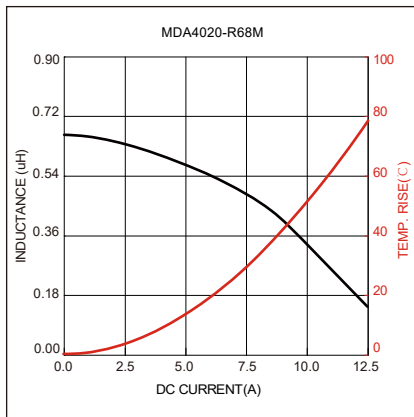
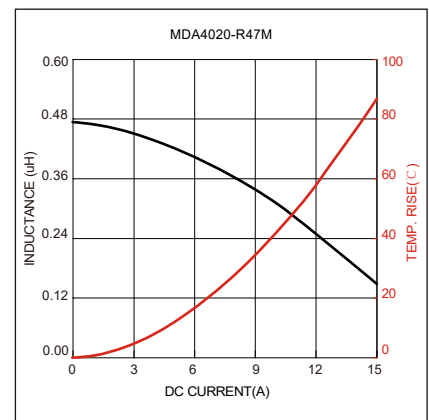
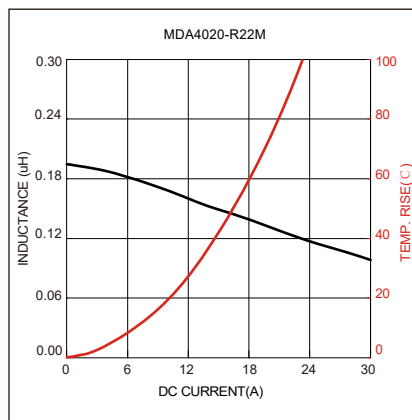
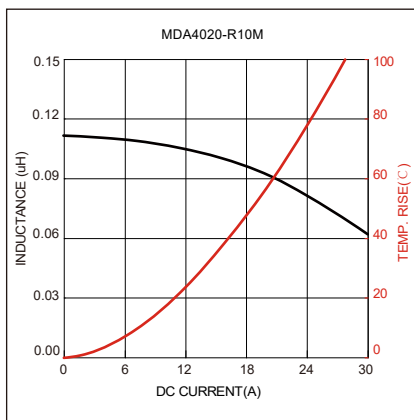
Part No	Inductance @ 100KHz/1V (μH)	Tolerance	Temperature Rise Current Typ. (A)	Temperature Rise Current Max. (A)	Saturation Current Typ. (A)	Saturation Current Max. (A)	DC Resistance Typ. (mΩ)	DC Resistance Max. (mΩ)
MDA4020-R10M	0.10	±20%	16.0	14.0	26.0	22.0	2.90	3.20
MDA4020-R22M	0.22	±20%	14.0	12.5	15.0	13.0	4.80	5.50
MDA4020-R47M	0.47	±20%	10.0	9.0	9.0	8.0	9.50	11.0
MDA4020-R68M	0.68	±20%	9.0	8.0	7.6	6.6	11.6	13.5
MDA4020-1R0M	1.00	±20%	7.5	6.5	5.5	5.0	19.0	22.0
MDA4020-1R5M	1.50	±20%	6.7	5.8	5.2	4.8	27.0	31.0
MDA4020-2R2M	2.20	±20%	5.5	5.0	4.5	4.0	41.0	48.0
MDA4020-3R3M	3.30	±20%	4.5	3.5	3.1	2.7	65.0	75.0
MDA4020-4R7M	4.70	±20%	3.8	3.2	2.8	2.5	84.0	95.0

Part No	Inductance @ 100KHz/1V (μH)	Tolerance	Temperature Rise Current Typ. (A)	Temperature Rise Current Max. (A)	Saturation Current Typ. (A)	Saturation Current Max. (A)	DC Resistance Typ. (mΩ)	DC Resistance Max. (mΩ)
MDA4020-5R6M	5.60	±20%	3.2	2.8	2.6	2.3	97.0	115
MDA4020-6R8M	6.80	±20%	2.9	2.5	2.4	2.1	131	157
MDA4020-8R2M	8.20	±20%	2.6	2.3	2.2	2.0	140	168
MDA4020-100M	10.0	±20%	2.4	2.2	2.1	1.9	165	215

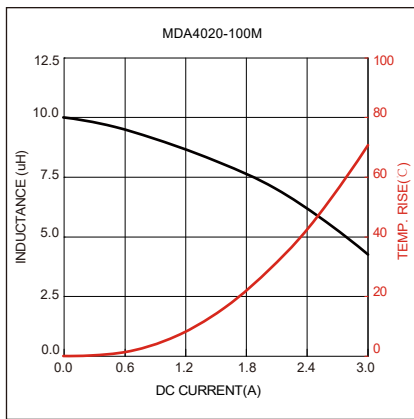
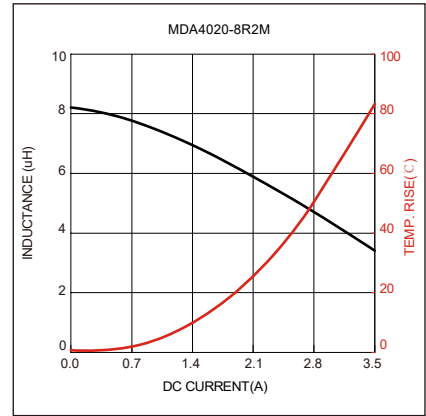
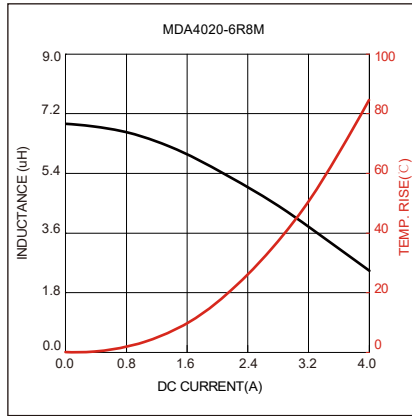
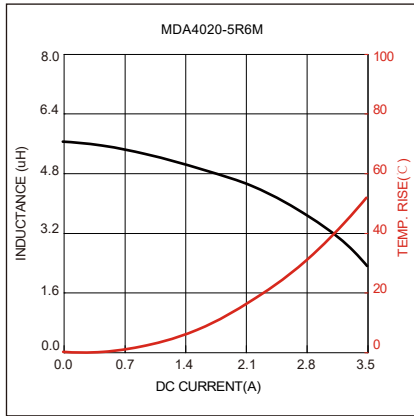
Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is  $\Delta T=40^{\circ}\text{C}$

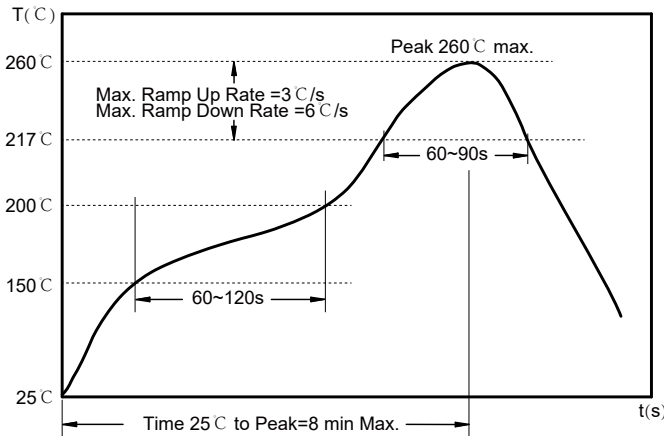
### Typical Electrical Characteristics:



Typical Electrical Characteristics:



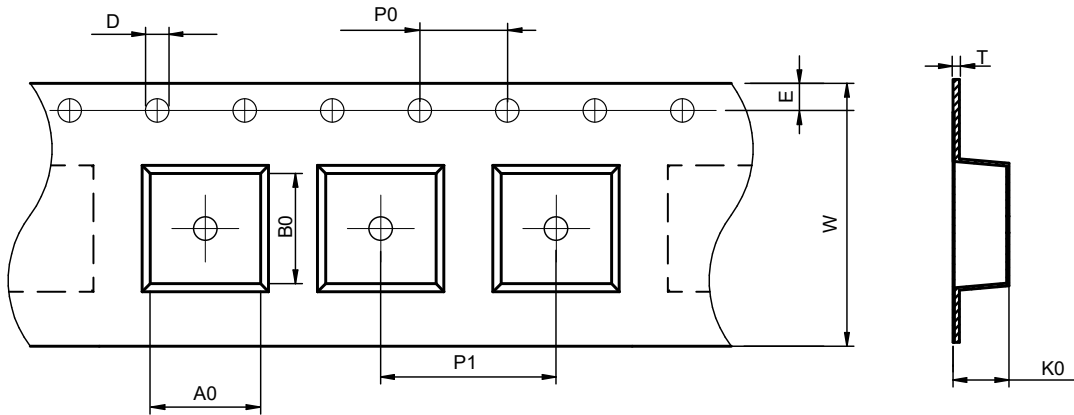
### Soldering Reflow:



Preheat condition: 150 ~200°C / 60~120 sec.  
 Allowed time above 217°C : 60~90 sec.  
 Max temperature: 260°C .  
 Max time at max temperature: 5 sec.  
 Allowed Reflow time: 2x max.

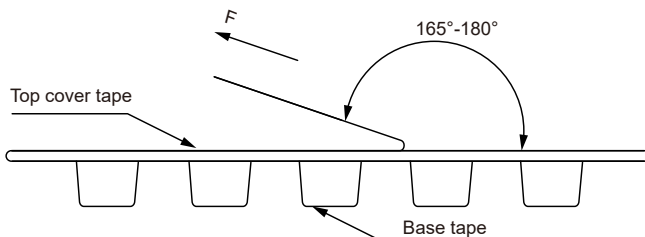
### Packaging Information:

#### Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDA4020	4.5±0.1	4.85±0.1	1.5±0.1	4.0±0.1	8.0±0.1	12.0±0.3	2.3±0.1	1.75±0.1	0.35±0.05

#### Peel force of top cover tape:

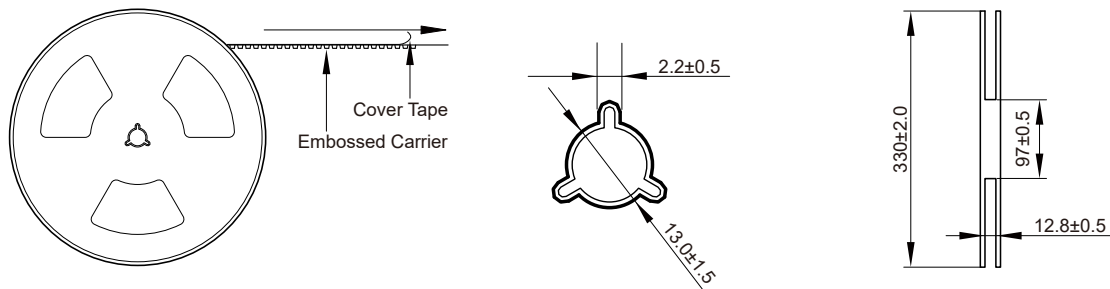


The peel force of top cover tape shall be between 0.1 to 1.3 N

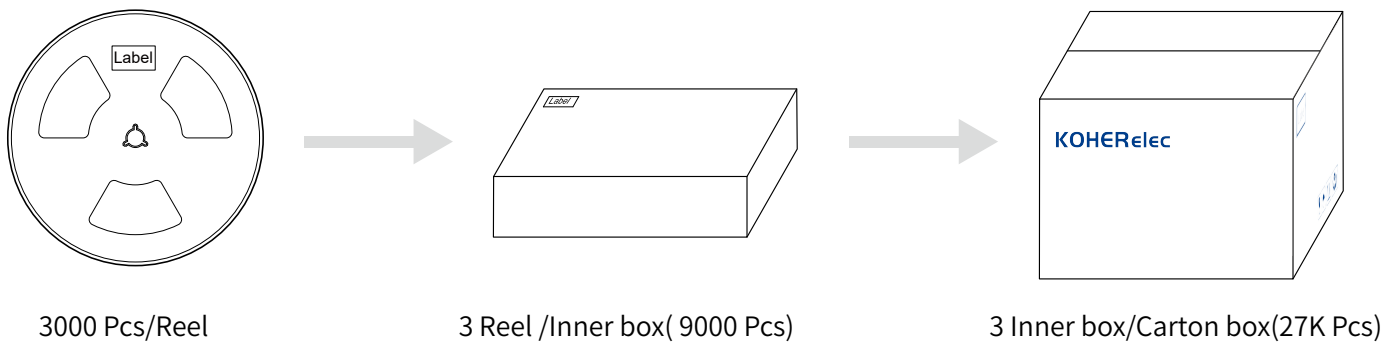
#### Product Marking:

Marking	K+Printing (Inductance)
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Reel Dimension: [mm]



Packaging Quantity:



Cautions and Warnings:

Storage Conditions :

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max).If the storage period elapses, the soldering of the terminal electrodes may deteriorate.The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components.The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does.As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- ⊖ [View MDA4020-6R8M on WIN SOURCE](#)
- ⊖ [KOHERShanghaiElectronics Co.,Ltd Information](#)

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- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management